

## KBP200 Thru 2010

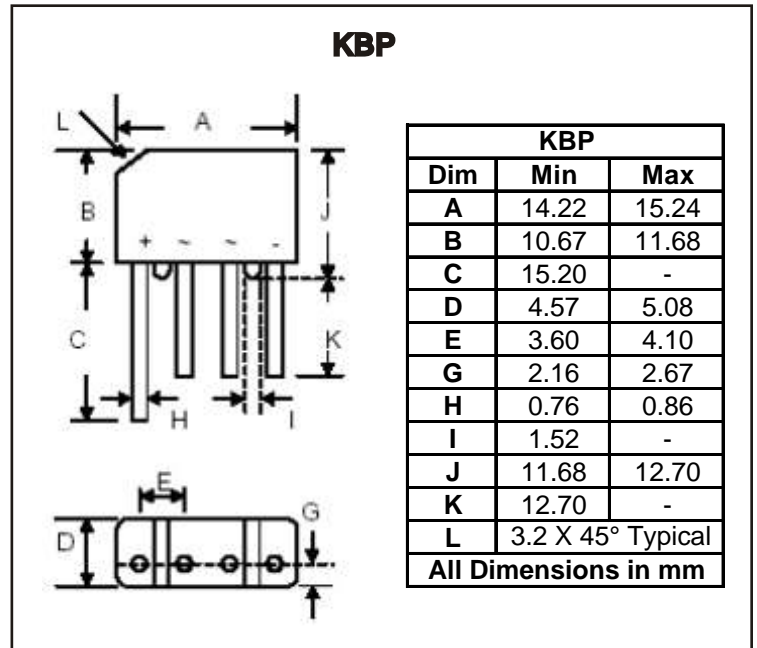
**Reverse Voltage: 50 - 1000 Volts**  
**Forward Current: 2.0 Amp**

### Features

- Diffused Junction
- Low Forward Voltage Drop
- High Current Capability
- High Reliability
- High Surge Current Capability
- Ideal for Printed Circuit Boards

### Mechanical Data

- Case: Molded Plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Weight: 1.7 grams (approx.)
- Mounting Position: Any
- Marking: Type Number



## Maximum Ratings and Electrical Characteristics

Single Phase, half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

CHARACTERISTICS	Symbol	KBP 200	KBP 201	KBP 202	KBP 204	KBP 206	KBP 208	KBP 2010	UNIT
Peak Repetitive Reverse Voltage	$V_{RRM}$								
Working Peak Reverse Voltage	$V_{RWM}$	50	100	200	400	600	800	1000	V
DC Blocking Voltage	$V_R$								
RMS Reverse Voltage	$V_{R(RMS)}$	35	70	140	280	420	560	700	V
Average Rectified Output Current @ $T_A = 50^\circ\text{C}$ (Note 1)	$I_O$	2.0							A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rate load (JEDEC Method)	$I_{FSM}$	60							A
Forward Voltage (per element) @ $I_F = 2.0\text{A}$	$V_{FM}$	1.1							V
Peak Reverse Current @ $T_A = 25^\circ\text{C}$	$I_{RM}$	10							uA
At Rated DC Blocking Voltage @ $T_A = 100^\circ\text{C}$		500							
Rating for Fusing ( $t < 8.3\text{ms}$ )	$I^2t$	15							$\text{A}^2\text{s}$
Typical Junction Capacitance per element (Note 2)	$C_j$	25							pF
Typical Thermal Resistance (Note 3)	$R_{\theta JA}$	30							K/W
Operating and Storage Temperature Range	$T_j, T_{STG}$	-55 to +160							$^\circ\text{C}$

- Note:**
1. Leads maintained at ambient temperature at a distance of 9.5mm from the case.
  2. Measured at 1.0 MHz and applied reverse voltage of 4.0V D.C.
  3. Thermal resistance junction to ambient mounted on PC board with  $12\text{mm}^2$  copper pad.

## Rating and Characteristic Curves (KBP200 - KBP2010)

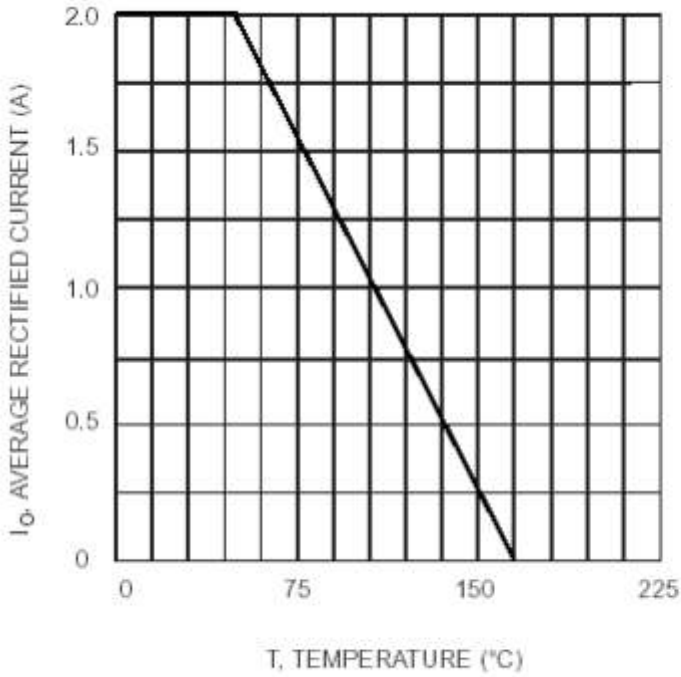


Fig. 1 Forward Current Derating Curve

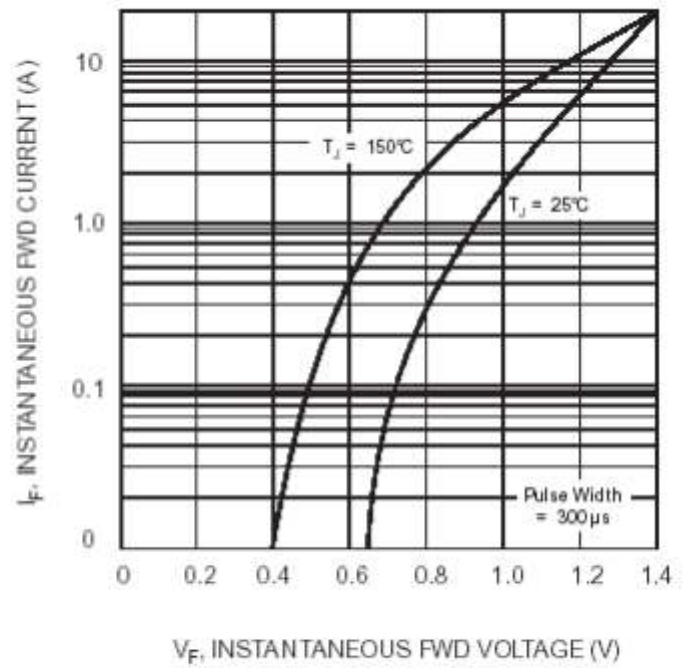


Fig. 2 Typical Fwd Characteristics

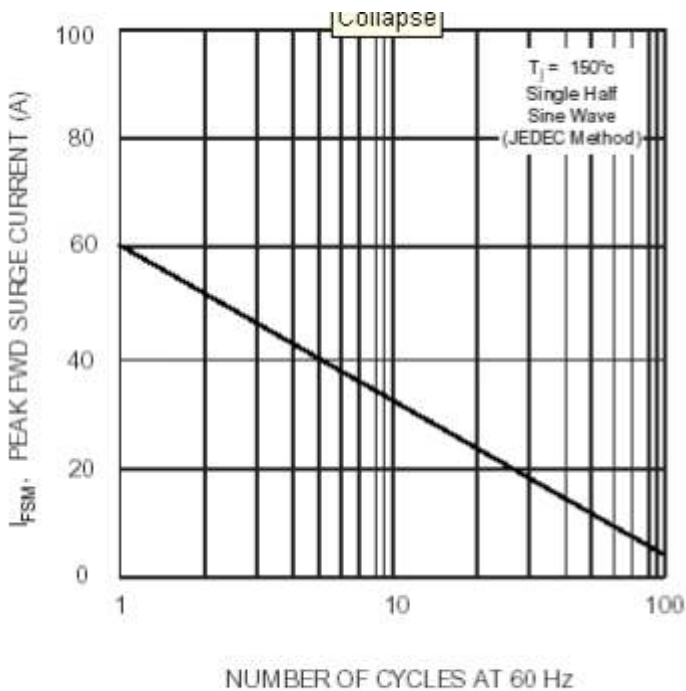


Fig. 3 Max Non-Repetitive Peak Fwd Surge Current

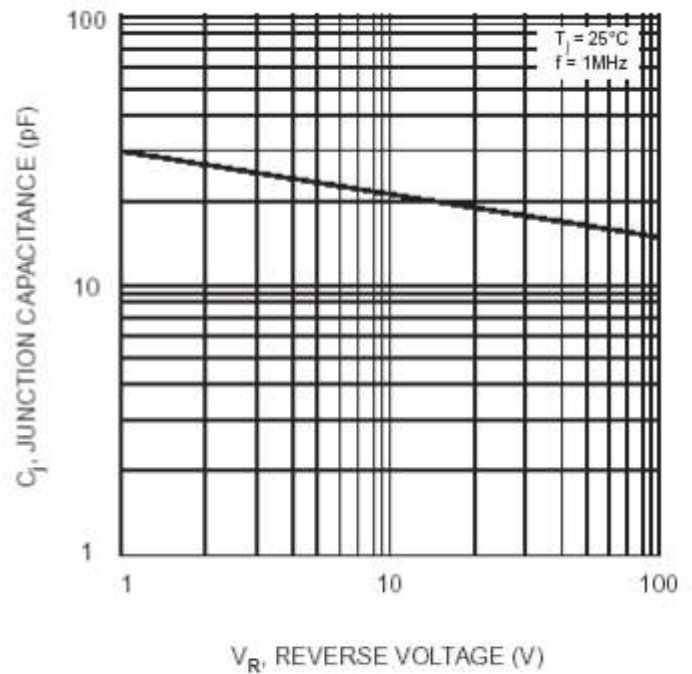


Fig. 4 Typical Junction Capacitance

## Rating and Characteristic Curves (KBP200 - KBP2010)

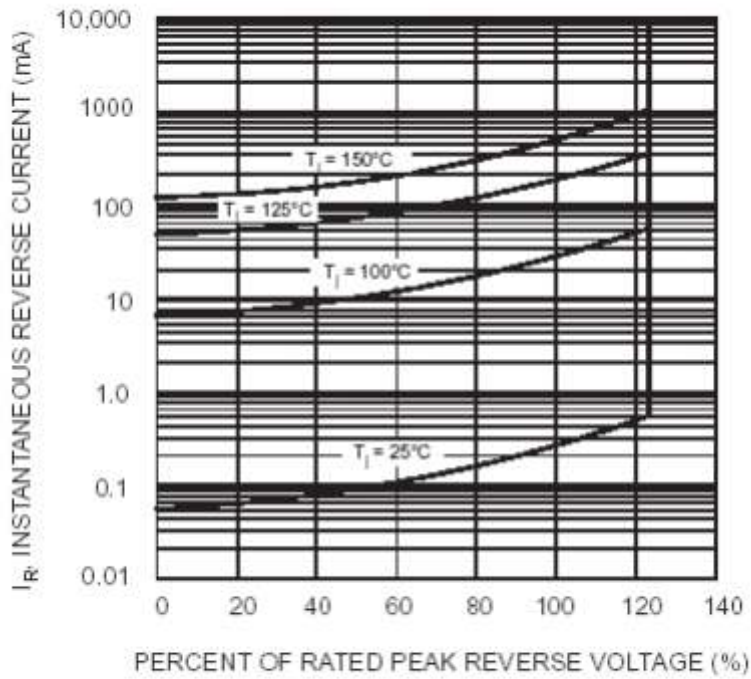


Fig. 5 Typical Reverse Characteristics

This datasheet has been download from:

[www.datasheetcatalog.com](http://www.datasheetcatalog.com)

Datasheets for electronics components.